COMPLIANT

HALOGEN

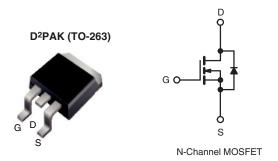
FREE



Vishay Siliconix

D Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.85		
Q _g (max.) (nC)	30			
Q _{gs} (nC)	4			
Q _{gd} (nC)	7			
Configuration	Single			



FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer Electronics
 - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies
 - SMPS
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB8N50D-GE3

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unless other	wise noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	500		
Gate-Source Voltage		V	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)	- V _{GS}	30			
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 10 V $T_C = 25^{\circ}$	C L	8.7		
	V _{GS} at 10 V	C I _D	5.5	Α	
Pulsed Drain Current ^a	I _{DM}	18			
Linear Derating Factor			1.25	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	29	mJ	
Maximum Power Dissipation		P _D	156	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	T _J = 125 °C	dV/dt	24	V/ns	
Reverse Diode dV/dt ^d		uv/at	0.37	V/IIS	
Soldering Recommendations (Peak Temperature) ^c	for 10 s		300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 5 Å.
- c. 1.6 mm from case.
- d. $I_{SD} \leq I_{D}$, starting T_{J} = 25 °C.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.8		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				I.	L		l
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 250 μA		0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		-	5	V
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	1 10	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$	$I_D = 4 \text{ A}$	_	0.70	0.85	Ω
Forward Transconductance ^a	9fs		= 20 V, I _D = 4 A	_	3	-	S
Dynamic	313	1 50	- , ,	L	l	1	L
Input Capacitance	C _{iss}		V -0V	-	527	_	
Output Capacitance	C _{oss}	† ,	$V_{GS} = 0 \text{ V}, \\ V_{DS} = 100 \text{ V},$		52	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	8	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		-	46	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	64	-	
Total Gate Charge	Qg			-	15	30	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 4 A, V_{DS} = 400 V$	-	4	-	nC
Gate-Drain Charge	Q _{gd}	1			7	-	1
Turn-On Delay Time	t _{d(on)}		V _{DD} = 400 V, I _D = 4 A		13	26	
Rise Time	t _r	V _{DD} :			16	32	no
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.1 \Omega, V_{GS} = 10 V$		-	17	34	ns
Fall Time	t _f			-	11	22	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		-	1.8	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8	
Pulsed Diode Forward Current	I _{SM}			-	-	32	A
Diode Forward Voltage	V_{SD}	T _J = 25 °C, I _S = 4 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 4 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 20 \text{ V}$		-	308	-	ns
Reverse Recovery Charge	Q _{rr}			-	1.8	-	μC
Reverse Recovery Current	I _{RRM}			-	11	-	Α

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

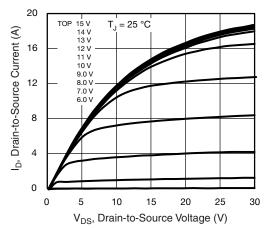


Fig. 1 - Typical Output Characteristics

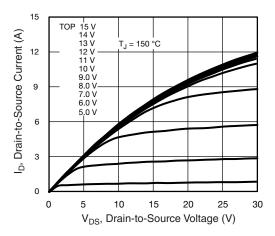


Fig. 2 - Typical Output Characteristics

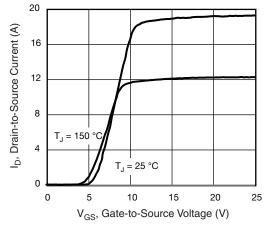


Fig. 3 - Typical Transfer Characteristics

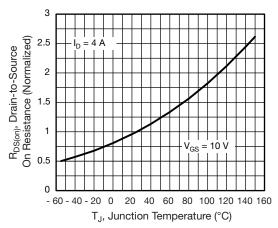


Fig. 4 - Normalized On-Resistance vs. Temperature

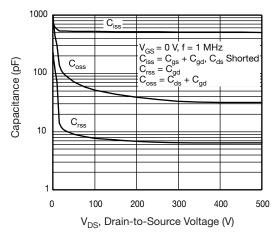


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

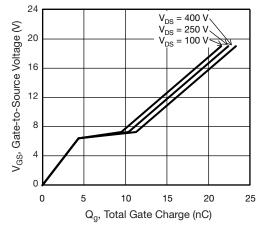


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



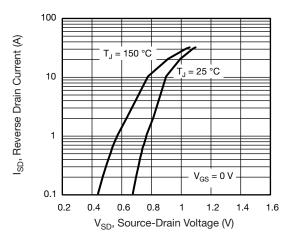


Fig. 7 - Typical Source-Drain Diode Forward Voltage

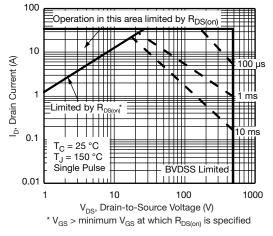


Fig. 8 - Maximum Safe Operating Area

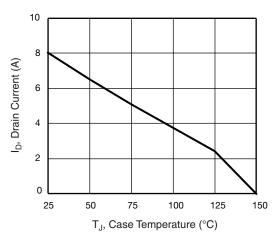


Fig. 9 - Maximum Drain Current vs. Case Temperature

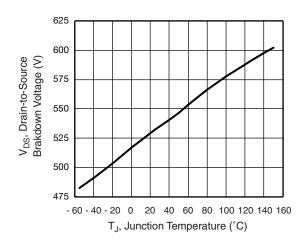


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

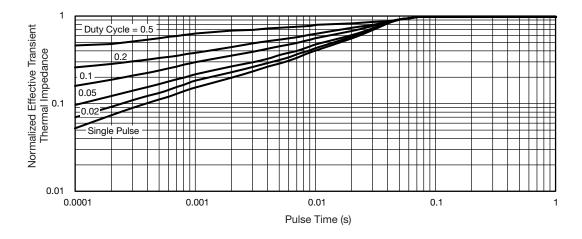


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



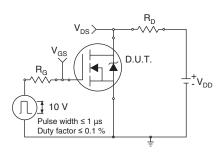


Fig. 12 - Switching Time Test Circuit

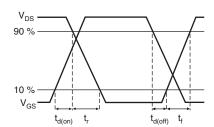


Fig. 13 - Switching Time Waveforms

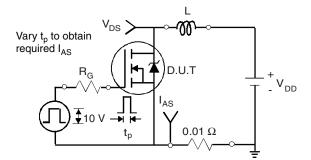


Fig. 14 - Unclamped Inductive Test Circuit

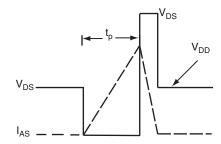


Fig. 15 - Unclamped Inductive Waveforms

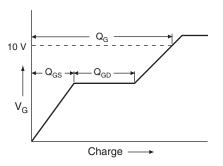


Fig. 16 - Basic Gate Charge Waveform

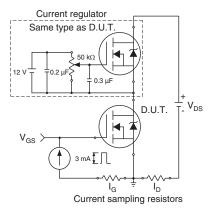
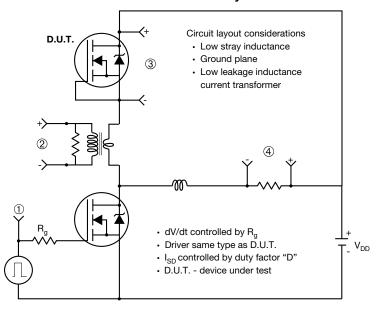


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



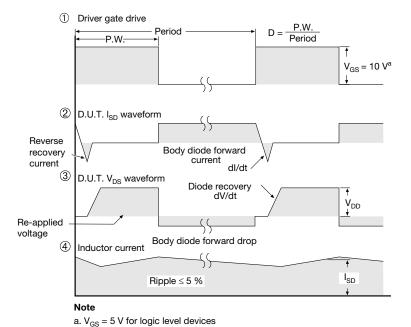


Fig. 18 - For N-Channel

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